

# SN54LV126A, SN74LV126A QUADRUPLE BUS BUFFER GATES WITH 3-STATE OUTPUTS

SCES131H – MARCH 1998 – REVISED APRIL 2005

- 2-V to 5.5-V  $V_{CC}$  Operation
- Max  $t_{pd}$  of 6.5 ns at 5 V
- Typical  $V_{OLP}$  (Output Ground Bounce)  
<0.8 V at  $V_{CC} = 3.3$  V,  $T_A = 25^\circ\text{C}$
- Typical  $V_{OHV}$  (Output  $V_{OH}$  Undershoot)  
>2.3 V at  $V_{CC} = 3.3$  V,  $T_A = 25^\circ\text{C}$
- Support Mixed-Mode Voltage Operation on All Ports
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)

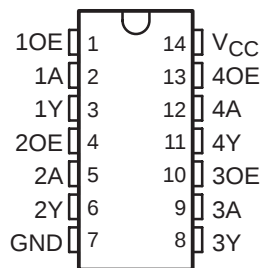
## description/ordering information

These quadruple bus buffer gates are designed for 2-V to 5.5-V  $V_{CC}$  operation.

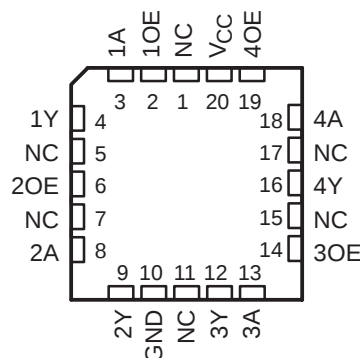
The 'LV126A devices feature independent line drivers with 3-state outputs. Each output is disabled when the associated output-enable (OE) input is low.

To ensure the high-impedance state during power up or power down, OE should be tied to GND through a pulldown resistor; the minimum value of the resistor is determined by the current-sourcing capability of the driver.

SN54LV126A . . . J OR W PACKAGE  
SN74LV126A . . . D, DB, DGV, NS, OR PW PACKAGE  
(TOP VIEW)



SN54LV126A . . . FK PACKAGE  
(TOP VIEW)



NC – No internal connection

## ORDERING INFORMATION

| $T_A$          | PACKAGE <sup>†</sup> |              | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|----------------------|--------------|-----------------------|------------------|
| -40°C to 85°C  | SOIC – D             | Tube of 50   | SN74LV126AD           | LV126A           |
|                |                      | Reel of 2500 | SN74LV126ADR          |                  |
|                | SOP – NS             | Reel of 2000 | SN74LV126ANSR         | 74LV126A         |
|                | SSOP – DB            | Reel of 2000 | SN74LV126ADBR         | LV126A           |
|                | TSSOP – PW           | Tube of 90   | SN74LV126APW          | LV126A           |
|                |                      | Reel of 2000 | SN74LV126APWR         |                  |
|                |                      | Reel of 250  | SN74LV126APWT         |                  |
| -55°C to 125°C | TVSOP – DGV          | Reel of 2000 | SN74LV126ADGVR        | LV126A           |
|                | CDIP – J             | Tube of 25   | SNJ54LV126AJ          | SNJ54LV126AJ     |
|                | CFP – W              | Tube of 150  | SNJ54LV126AW          | SNJ54LV126AW     |
|                | LCCC – FK            | Tube of 55   | SNJ54LV126AFK         | SNJ54LV126AFK    |

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).



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**TEXAS  
INSTRUMENTS**

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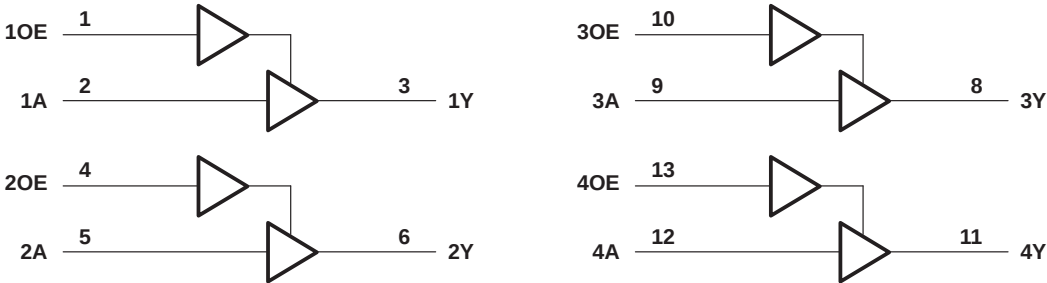
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FUNCTION TABLE  
(each buffer)

| INPUTS |   | OUTPUT<br>Y |
|--------|---|-------------|
| OE     | A |             |
| H      | H | H           |
| H      | L | L           |
| L      | X | Z           |

## logic diagram (positive logic)



Pin numbers shown are for the D, DB, DGV, J, NS, PW, and W packages.

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

|                                                                                                  |                            |
|--------------------------------------------------------------------------------------------------|----------------------------|
| Supply voltage range, $V_{CC}$                                                                   | –0.5 V to 7 V              |
| Input voltage range, $V_I$ (see Note 1)                                                          | –0.5 V to 7 V              |
| Voltage range applied to any output in the high-impedance or power-off state, $V_O$ (see Note 1) | –0.5 V to 7 V              |
| Output voltage range, $V_O$ (see Notes 1 and 2)                                                  | –0.5 V to $V_{CC} + 0.5$ V |
| Input clamp current, $I_{IK}$ ( $V_I < 0$ )                                                      | –20 mA                     |
| Output clamp current, $I_{OK}$ ( $V_O < 0$ )                                                     | –50 mA                     |
| Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )                                       | ±35 mA                     |
| Continuous current through $V_{CC}$ or GND                                                       | ±70 mA                     |
| Package thermal impedance, $\theta_{JA}$ (see Note 3):                                           |                            |
| D package                                                                                        | 86°C/W                     |
| DB package                                                                                       | 96°C/W                     |
| DGV package                                                                                      | 127°C/W                    |
| NS package                                                                                       | 76°C/W                     |
| PW package                                                                                       | 113°C/W                    |
| Storage temperature range, $T_{stg}$                                                             | –65°C to 150°C             |

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
- The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
  - This value is limited to 5.5 V maximum.
  - The package thermal impedance is calculated in accordance with JESD 51-7.

# SN54LV126A, SN74LV126A QUADRUPLE BUS BUFFER GATES WITH 3-STATE OUTPUTS

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## recommended operating conditions (see Note 4)

|                 |                                    |                                  | SN54LV126A            |                 | SN74LV126A            |                 | UNIT |
|-----------------|------------------------------------|----------------------------------|-----------------------|-----------------|-----------------------|-----------------|------|
|                 |                                    |                                  | MIN                   | MAX             | MIN                   | MAX             |      |
| V <sub>CC</sub> | Supply voltage                     |                                  | 2                     | 5.5             | 2                     | 5.5             | V    |
| V <sub>IH</sub> | High-level input voltage           | V <sub>CC</sub> = 2 V            | 1.5                   |                 | 1.5                   |                 | V    |
|                 |                                    | V <sub>CC</sub> = 2.3 V to 2.7 V | V <sub>CC</sub> × 0.7 |                 | V <sub>CC</sub> × 0.7 |                 |      |
|                 |                                    | V <sub>CC</sub> = 3 V to 3.6 V   | V <sub>CC</sub> × 0.7 |                 | V <sub>CC</sub> × 0.7 |                 |      |
|                 |                                    | V <sub>CC</sub> = 4.5 V to 5.5 V | V <sub>CC</sub> × 0.7 |                 | V <sub>CC</sub> × 0.7 |                 |      |
| V <sub>IL</sub> | Low-level input voltage            | V <sub>CC</sub> = 2 V            | 0.5                   |                 | 0.5                   |                 | V    |
|                 |                                    | V <sub>CC</sub> = 2.3 V to 2.7 V | V <sub>CC</sub> × 0.3 |                 | V <sub>CC</sub> × 0.3 |                 |      |
|                 |                                    | V <sub>CC</sub> = 3 V to 3.6 V   | V <sub>CC</sub> × 0.3 |                 | V <sub>CC</sub> × 0.3 |                 |      |
|                 |                                    | V <sub>CC</sub> = 4.5 V to 5.5 V | V <sub>CC</sub> × 0.3 |                 | V <sub>CC</sub> × 0.3 |                 |      |
| V <sub>I</sub>  | Input voltage                      |                                  | 0                     | 5.5             | 0                     | 5.5             | V    |
| V <sub>O</sub>  | Output voltage                     | High or low state                | 0                     | V <sub>CC</sub> | 0                     | V <sub>CC</sub> | V    |
|                 |                                    | 3-state                          | 0                     | 5.5             | 0                     | 5.5             |      |
| I <sub>OH</sub> | High-level output current          | V <sub>CC</sub> = 2 V            | –50                   |                 | –50                   |                 | μA   |
|                 |                                    | V <sub>CC</sub> = 2.3 V to 2.7 V | –2                    |                 | –2                    |                 | mA   |
|                 |                                    | V <sub>CC</sub> = 3 V to 3.6 V   | –8                    |                 | –8                    |                 |      |
|                 |                                    | V <sub>CC</sub> = 4.5 V to 5.5 V | –16                   |                 | –16                   |                 |      |
| I <sub>OL</sub> | Low-level output current           | V <sub>CC</sub> = 2 V            | 50                    |                 | 50                    |                 | μA   |
|                 |                                    | V <sub>CC</sub> = 2.3 V to 2.7 V | 2                     |                 | 2                     |                 | mA   |
|                 |                                    | V <sub>CC</sub> = 3 V to 3.6 V   | 8                     |                 | 8                     |                 |      |
|                 |                                    | V <sub>CC</sub> = 4.5 V to 5.5 V | 16                    |                 | 16                    |                 |      |
| Δt/Δv           | Input transition rise or fall rate | V <sub>CC</sub> = 2.3 V to 2.7 V | 200                   |                 | 200                   |                 | ns/V |
|                 |                                    | V <sub>CC</sub> = 3 V to 3.6 V   | 100                   |                 | 100                   |                 |      |
|                 |                                    | V <sub>CC</sub> = 4.5 V to 5.5 V | 20                    |                 | 20                    |                 |      |
| T <sub>A</sub>  | Operating free-air temperature     |                                  | –55                   | 125             | –40                   | 85              | °C   |

NOTE 4: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER        | TEST CONDITIONS                                             | V <sub>CC</sub> | SN54LV126A           |     |     | SN74LV126A           |     |     | UNIT |
|------------------|-------------------------------------------------------------|-----------------|----------------------|-----|-----|----------------------|-----|-----|------|
|                  |                                                             |                 | MIN                  | TYP | MAX | MIN                  | TYP | MAX |      |
| V <sub>OH</sub>  | I <sub>OH</sub> = –50 μA                                    | 2 V to 5.5 V    | V <sub>CC</sub> –0.1 |     |     | V <sub>CC</sub> –0.1 |     |     | V    |
|                  | I <sub>OH</sub> = –2 mA                                     | 2.3 V           | 2                    |     |     | 2                    |     |     |      |
|                  | I <sub>OH</sub> = –8 mA                                     | 3 V             | 2.48                 |     |     | 2.48                 |     |     |      |
|                  | I <sub>OH</sub> = –16 mA                                    | 4.5 V           | 3.8                  |     |     | 3.8                  |     |     |      |
| V <sub>OL</sub>  | I <sub>OL</sub> = 50 μA                                     | 2 V to 5.5 V    | 0.1                  |     |     | 0.1                  |     |     | V    |
|                  | I <sub>OL</sub> = 2 mA                                      | 2.3 V           | 0.4                  |     |     | 0.4                  |     |     |      |
|                  | I <sub>OL</sub> = 8 mA                                      | 3 V             | 0.44                 |     |     | 0.44                 |     |     |      |
|                  | I <sub>OL</sub> = 16 mA                                     | 4.5 V           | 0.55                 |     |     | 0.55                 |     |     |      |
| I <sub>I</sub>   | V <sub>I</sub> = 5.5 V or GND                               | 0 to 5.5 V      | ±1                   |     |     | ±1                   |     |     | μA   |
| I <sub>OZ</sub>  | V <sub>O</sub> = V <sub>CC</sub> or GND                     | 5.5 V           | ±5                   |     |     | ±5                   |     |     | μA   |
| I <sub>CC</sub>  | V <sub>I</sub> = V <sub>CC</sub> or GND, I <sub>O</sub> = 0 | 5.5 V           | 20                   |     |     | 20                   |     |     | μA   |
| I <sub>off</sub> | V <sub>I</sub> or V <sub>O</sub> = 0 to 5.5 V               | 0               | 5                    |     |     | 5                    |     |     | μA   |
| C <sub>i</sub>   | V <sub>I</sub> = V <sub>CC</sub> or GND                     | 3.3 V           | 1.6                  |     |     | 1.6                  |     |     | pF   |

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# SN54LV126A, SN74LV126A QUADRUPLE BUS BUFFER GATES WITH 3-STATE OUTPUTS

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switching characteristics over recommended operating free-air temperature range,  
 $V_{CC} = 2.5\text{ V} \pm 0.2\text{ V}$  (unless otherwise noted) (see Figure 1)

| PARAMETER   | FROM<br>(INPUT) | TO<br>(OUTPUT) | LOAD<br>CAPACITANCE  | $T_A = 25^\circ\text{C}$ |       |     | SN54LV126A |       | SN74LV126A |      | UNIT |
|-------------|-----------------|----------------|----------------------|--------------------------|-------|-----|------------|-------|------------|------|------|
|             |                 |                |                      | MIN                      | TYP   | MAX | MIN        | MAX   | MIN        | MAX  |      |
| $t_{pd}$    | A               | Y              | $C_L = 15\text{ pF}$ | 7.1*                     | 13*   |     | 1*         | 15.5* | 1          | 15.5 | ns   |
| $t_{en}$    | OE              | Y              |                      | 7.4*                     | 13*   |     | 1*         | 15.5* | 1          | 15.5 |      |
| $t_{dis}$   | OE              | Y              |                      | 5.7*                     | 14.7* |     | 1*         | 17*   | 1          | 17   |      |
| $t_{pd}$    | A               | Y              | $C_L = 50\text{ pF}$ | 9.2                      | 16.5  |     | 1          | 18.5  | 1          | 18.5 | ns   |
| $t_{en}$    | OE              | Y              |                      | 9.5                      | 16.5  |     | 1          | 18.5  | 1          | 18.5 |      |
| $t_{dis}$   | OE              | Y              |                      | 8.1                      | 18.2  |     | 15         | 20.5  | 1          | 20.5 |      |
| $t_{sk(o)}$ |                 |                |                      |                          | 2     |     |            |       |            | 2    |      |

\* On products compliant to MIL-PRF-38535, this parameter is not production tested.

switching characteristics over recommended operating free-air temperature range,  
 $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$  (unless otherwise noted) (see Figure 1)

| PARAMETER   | FROM<br>(INPUT) | TO<br>(OUTPUT) | LOAD<br>CAPACITANCE  | $T_A = 25^\circ\text{C}$ |      |     | SN54LV126A |       | SN74LV126A |      | UNIT |
|-------------|-----------------|----------------|----------------------|--------------------------|------|-----|------------|-------|------------|------|------|
|             |                 |                |                      | MIN                      | TYP  | MAX | MIN        | MAX   | MIN        | MAX  |      |
| $t_{pd}$    | A               | Y              | $C_L = 15\text{ pF}$ | 5*                       | 8*   |     | 1*         | 9.5*  | 1          | 9.5  | ns   |
| $t_{en}$    | OE              | Y              |                      | 5.1*                     | 8*   |     | 1*         | 9.5*  | 1          | 9.5  |      |
| $t_{dis}$   | OE              | Y              |                      | 4.4*                     | 9.7* |     | 1*         | 11.5* | 1          | 11.5 |      |
| $t_{pd}$    | A               | Y              | $C_L = 50\text{ pF}$ | 6.4                      | 11.5 |     | 1          | 13    | 1          | 13   | ns   |
| $t_{en}$    | OE              | Y              |                      | 6.6                      | 11.5 |     | 1          | 13    | 1          | 13   |      |
| $t_{dis}$   | OE              | Y              |                      | 6.1                      | 13.2 |     | 1          | 15    | 1          | 15   |      |
| $t_{sk(o)}$ |                 |                |                      |                          | 1.5  |     |            |       |            | 1.5  |      |

\* On products compliant to MIL-PRF-38535, this parameter is not production tested.

switching characteristics over recommended operating free-air temperature range,  
 $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$  (unless otherwise noted) (see Figure 1)

| PARAMETER   | FROM<br>(INPUT) | TO<br>(OUTPUT) | LOAD<br>CAPACITANCE  | $T_A = 25^\circ\text{C}$ |      |     | SN54LV126A |      | SN74LV126A |     | UNIT |
|-------------|-----------------|----------------|----------------------|--------------------------|------|-----|------------|------|------------|-----|------|
|             |                 |                |                      | MIN                      | TYP  | MAX | MIN        | MAX  | MIN        | MAX |      |
| $t_{pd}$    | A               | Y              | $C_L = 15\text{ pF}$ | 3.5*                     | 5.5* |     | 1*         | 6.5* | 1          | 6.5 | ns   |
| $t_{en}$    | OE              | Y              |                      | 3.6*                     | 5.1* |     | 1*         | 6*   | 1          | 6   |      |
| $t_{dis}$   | OE              | Y              |                      | 3.3*                     | 6.8* |     | 1*         | 8*   | 1          | 8   |      |
| $t_{pd}$    | A               | Y              | $C_L = 50\text{ pF}$ | 4.6                      | 7.5  |     | 1          | 8.5  | 1          | 8.5 | ns   |
| $t_{en}$    | OE              | Y              |                      | 4.6                      | 7.1  |     | 1          | 8    | 1          | 8   |      |
| $t_{dis}$   | OE              | Y              |                      | 4.3                      | 8.8  |     | 1          | 10   | 1          | 10  |      |
| $t_{sk(o)}$ |                 |                |                      |                          | 1    |     |            |      |            | 1   |      |

\* On products compliant to MIL-PRF-38535, this parameter is not production tested.

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**SN54LV126A, SN74LV126A**  
**QUADRUPLER BUS BUFFER GATES**  
**WITH 3-STATE OUTPUTS**

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**noise characteristics,  $V_{CC} = 3.3\text{ V}$ ,  $C_L = 50\text{ pF}$ ,  $T_A = 25^\circ\text{C}$  (see Note 5)**

| PARAMETER   |                                        | SN74LV126A |      |      | UNIT |
|-------------|----------------------------------------|------------|------|------|------|
|             |                                        | MIN        | TYP  | MAX  |      |
| $V_{OL(P)}$ | Quiet output, maximum dynamic $V_{OL}$ |            | 0.3  | 0.8  | V    |
| $V_{OL(V)}$ | Quiet output, minimum dynamic $V_{OL}$ |            | -0.2 | -0.8 | V    |
| $V_{OH(V)}$ | Quiet output, minimum dynamic $V_{OH}$ |            | 3.1  |      | V    |
| $V_{IH(D)}$ | High-level dynamic input voltage       | 2.31       |      |      | V    |
| $V_{IL(D)}$ | Low-level dynamic input voltage        |            |      | 0.97 | V    |

NOTE 5: Characteristics are for surface-mount packages only.

**operating characteristics,  $T_A = 25^\circ\text{C}$**

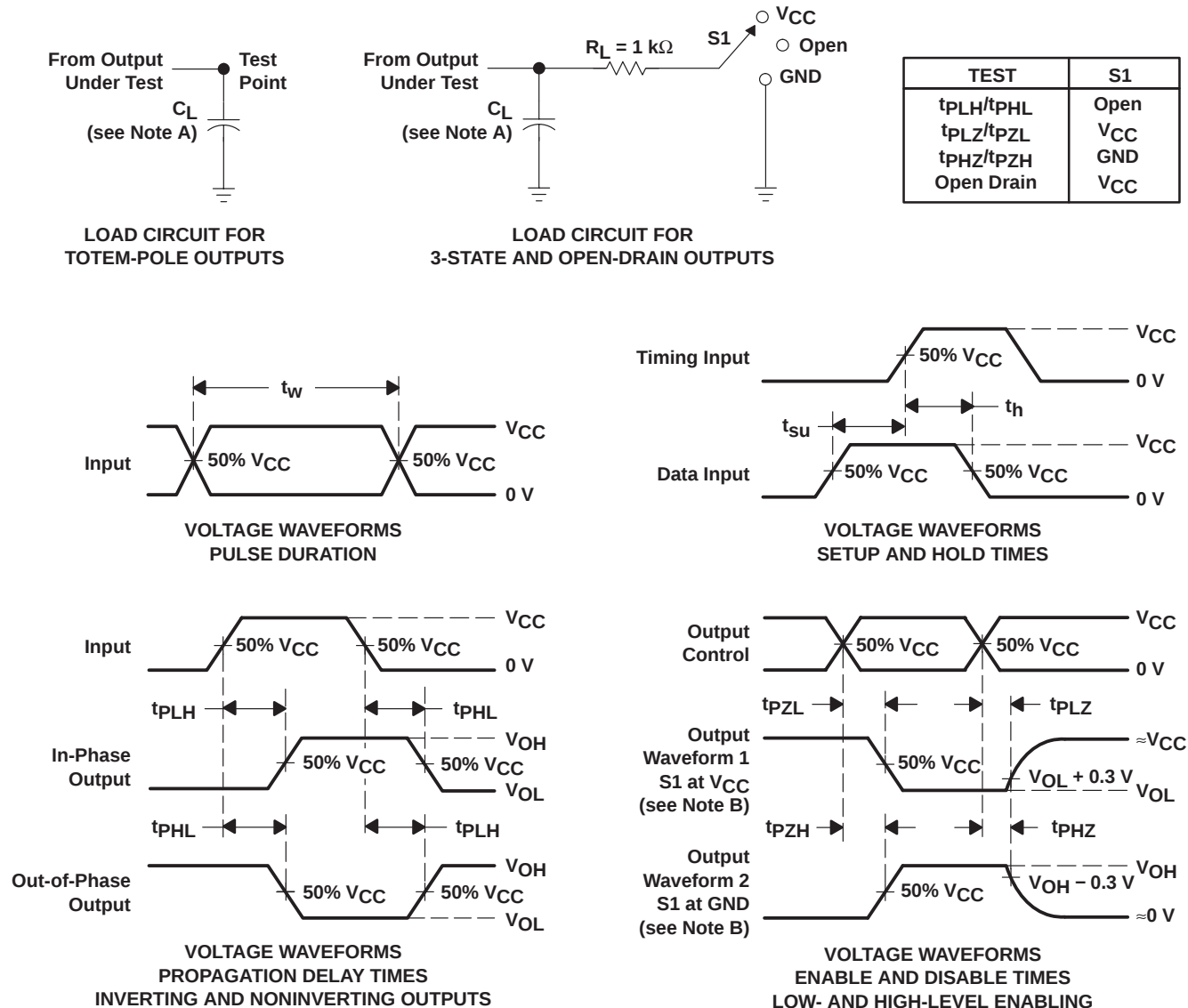
| PARAMETER |                               | TEST CONDITIONS                                               | $V_{CC}$ | TYP  | UNIT |
|-----------|-------------------------------|---------------------------------------------------------------|----------|------|------|
| $C_{pd}$  | Power dissipation capacitance | Outputs enabled<br>$C_L = 50\text{ pF}$ , $f = 10\text{ MHz}$ | 3.3 V    | 14.4 | pF   |
|           |                               |                                                               | 5 V      | 15.9 |      |



# SN54LV126A, SN74LV126A QUADRUPLE BUS BUFFER GATES WITH 3-STATE OUTPUTS

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## PARAMETER MEASUREMENT INFORMATION



- NOTES:
- $C_L$  includes probe and jig capacitance.
  - Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
  - All input pulses are supplied by generators having the following characteristics:  $PRR \leq 1\text{ MHz}$ ,  $Z_O = 50\ \Omega$ ,  $t_r \leq 3\text{ ns}$ ,  $t_f \leq 3\text{ ns}$ .
  - The outputs are measured one at a time, with one input transition per measurement.
  - $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - $t_{PHL}$  and  $t_{PLH}$  are the same as  $t_{pd}$ .
  - All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

**PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| SN74LV126AD      | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV126ADBR    | ACTIVE                | SSOP         | DB              | 14   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV126ADBRE4  | ACTIVE                | SSOP         | DB              | 14   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV126ADBRG4  | ACTIVE                | SSOP         | DB              | 14   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV126ADE4    | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV126ADG4    | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV126ADGVR   | ACTIVE                | TVSOP        | DGV             | 14   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV126ADGVRE4 | ACTIVE                | TVSOP        | DGV             | 14   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV126ADGVRG4 | ACTIVE                | TVSOP        | DGV             | 14   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV126ADR     | ACTIVE                | SOIC         | D               | 14   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV126ADRE4   | ACTIVE                | SOIC         | D               | 14   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV126ADRG4   | ACTIVE                | SOIC         | D               | 14   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV126ANSR    | ACTIVE                | SO           | NS              | 14   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV126ANSRE4  | ACTIVE                | SO           | NS              | 14   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV126ANSRG4  | ACTIVE                | SO           | NS              | 14   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV126APW     | ACTIVE                | TSSOP        | PW              | 14   | 90          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV126APWE4   | ACTIVE                | TSSOP        | PW              | 14   | 90          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV126APWG4   | ACTIVE                | TSSOP        | PW              | 14   | 90          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV126APWR    | ACTIVE                | TSSOP        | PW              | 14   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV126APWRE4  | ACTIVE                | TSSOP        | PW              | 14   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV126APWRG4  | ACTIVE                | TSSOP        | PW              | 14   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV126APWT    | ACTIVE                | TSSOP        | PW              | 14   | 250         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV126APWTE4  | ACTIVE                | TSSOP        | PW              | 14   | 250         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV126APWTG4  | ACTIVE                | TSSOP        | PW              | 14   | 250         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |

<sup>(1)</sup> The marketing status values are defined as follows:

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**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBsolete:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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**TAPE AND REEL INFORMATION**
**REEL DIMENSIONS**

**TAPE DIMENSIONS**

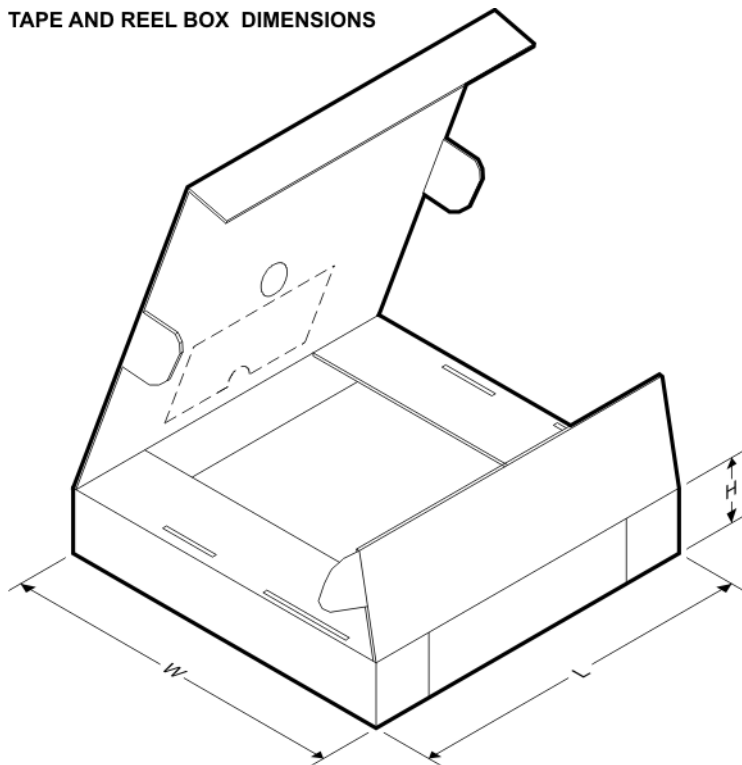

|    |                                                           |
|----|-----------------------------------------------------------|
| A0 | Dimension designed to accommodate the component width     |
| B0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

**TAPE AND REEL INFORMATION**

\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74LV126ADBR  | SSOP         | DB              | 14   | 2000 | 330.0              | 16.4               | 8.2     | 6.6     | 2.5     | 12.0    | 16.0   | Q1            |
| SN74LV126ADGVR | TVSOP        | DGV             | 14   | 2000 | 330.0              | 12.4               | 6.8     | 4.0     | 1.6     | 8.0     | 12.0   | Q1            |
| SN74LV126ADR   | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| SN74LV126ANSR  | SO           | NS              | 14   | 2000 | 330.0              | 16.4               | 8.2     | 10.5    | 2.5     | 12.0    | 16.0   | Q1            |
| SN74LV126APWR  | TSSOP        | PW              | 14   | 2000 | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |
| SN74LV126APWT  | TSSOP        | PW              | 14   | 250  | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



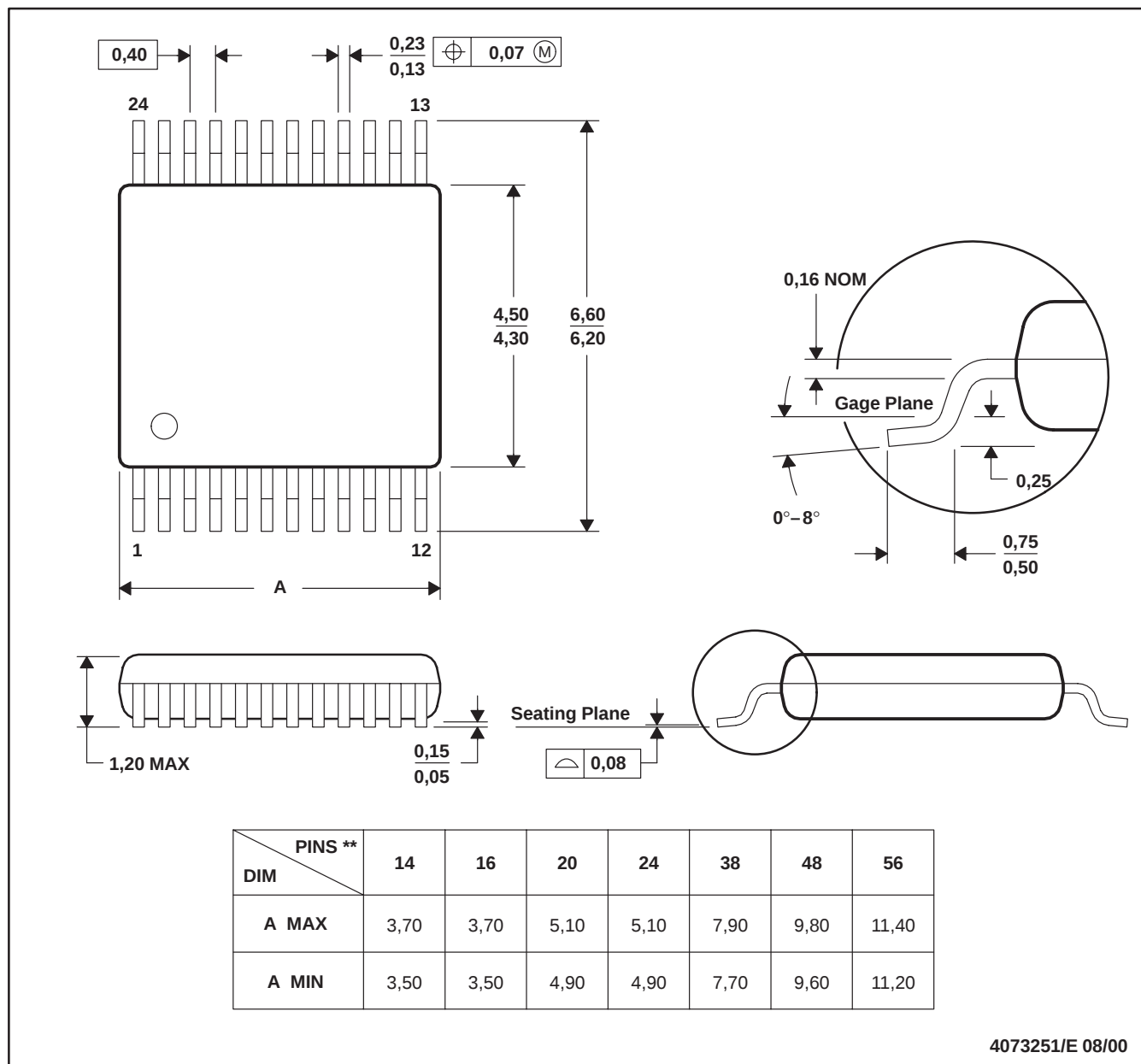
\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74LV126ADBR  | SSOP         | DB              | 14   | 2000 | 367.0       | 367.0      | 38.0        |
| SN74LV126ADGVR | TVSOP        | DGV             | 14   | 2000 | 367.0       | 367.0      | 35.0        |
| SN74LV126ADR   | SOIC         | D               | 14   | 2500 | 367.0       | 367.0      | 38.0        |
| SN74LV126ANSR  | SO           | NS              | 14   | 2000 | 367.0       | 367.0      | 38.0        |
| SN74LV126APWR  | TSSOP        | PW              | 14   | 2000 | 367.0       | 367.0      | 35.0        |
| SN74LV126APWT  | TSSOP        | PW              | 14   | 250  | 367.0       | 367.0      | 35.0        |

## DGV (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

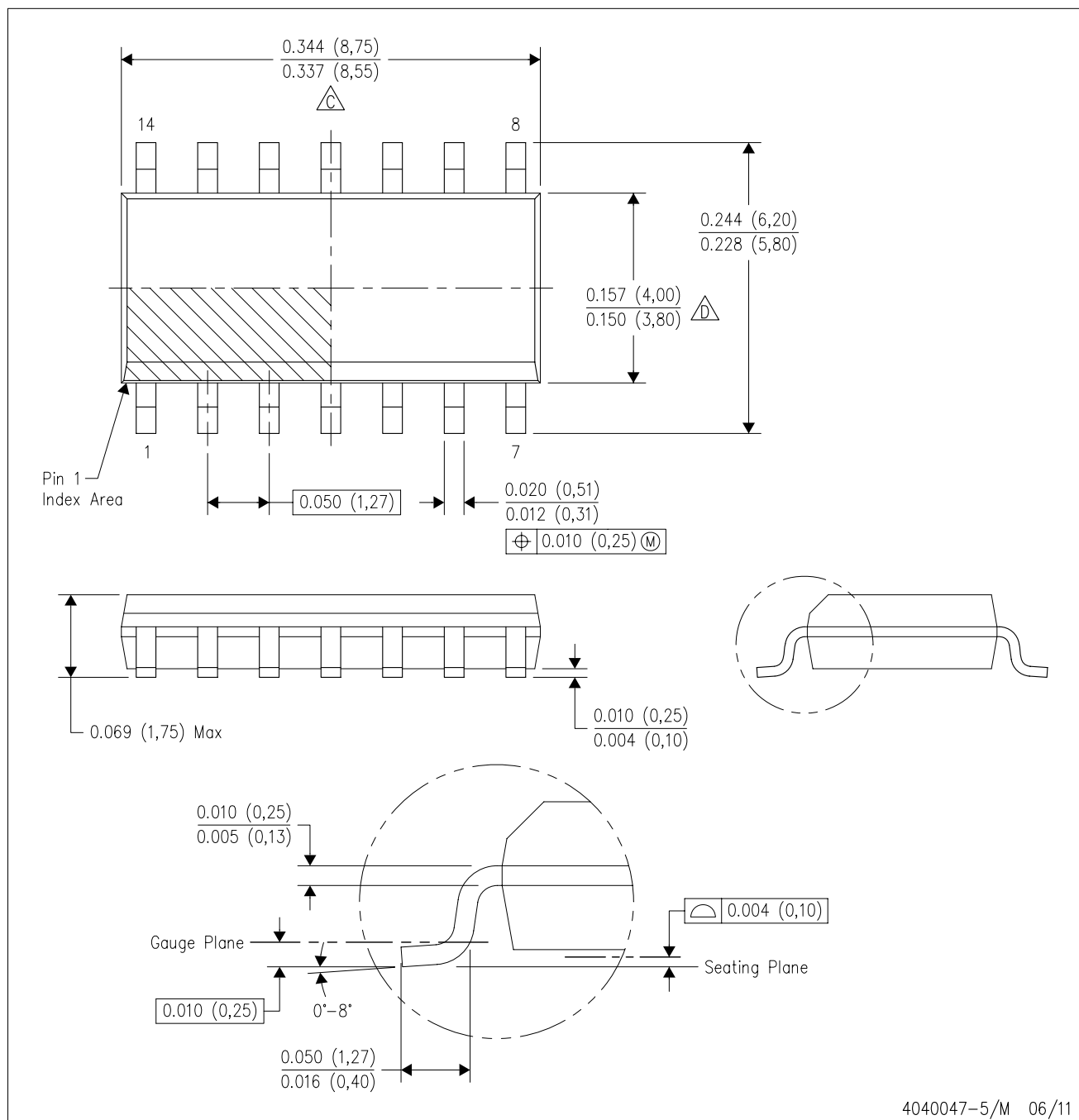
24 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.  
 D. Falls within JEDEC: 24/48 Pins – MO-153  
 14/16/20/56 Pins – MO-194

D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



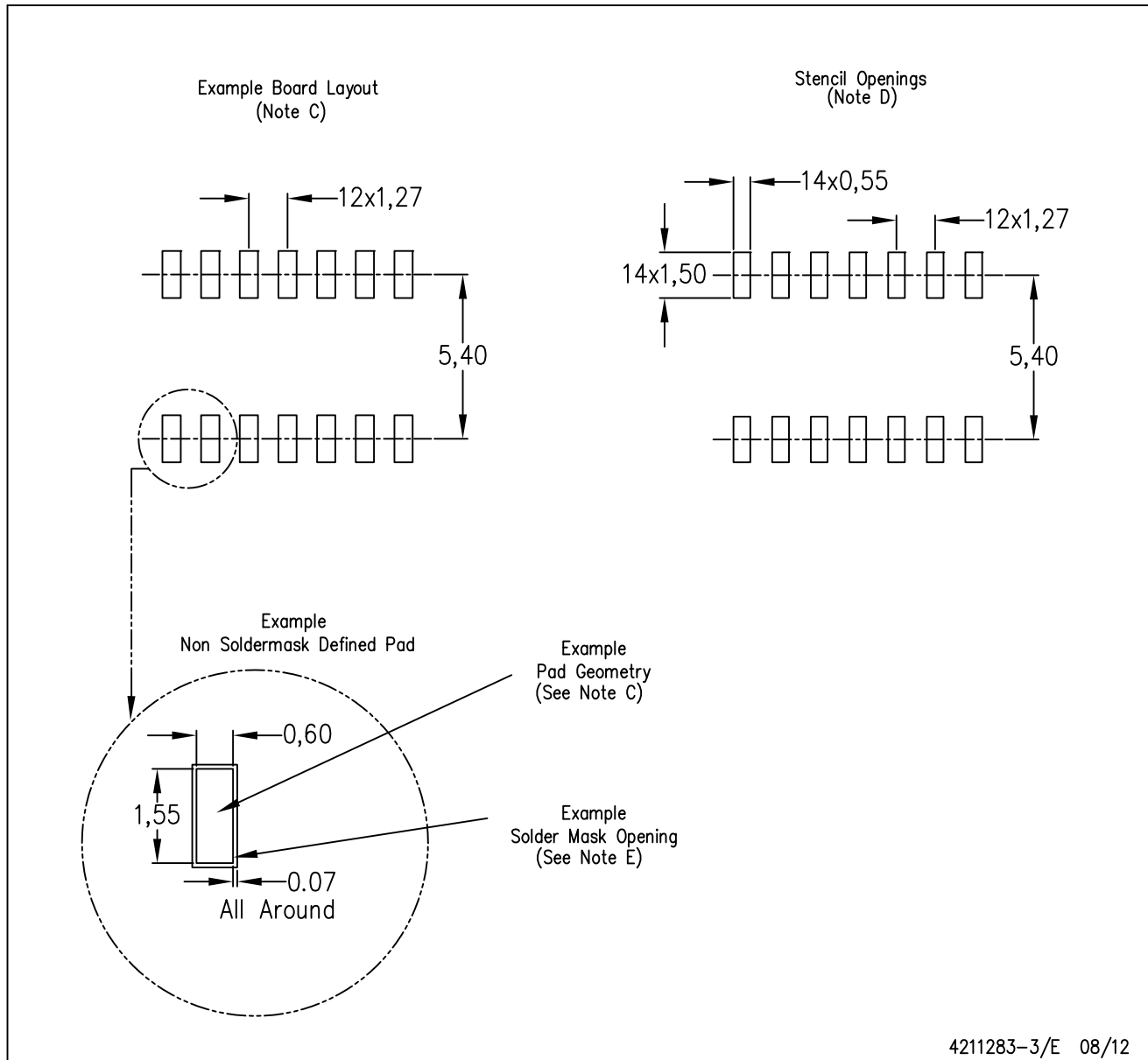
4040047-5/M 06/11

NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.

D (R-PDSO-G14)

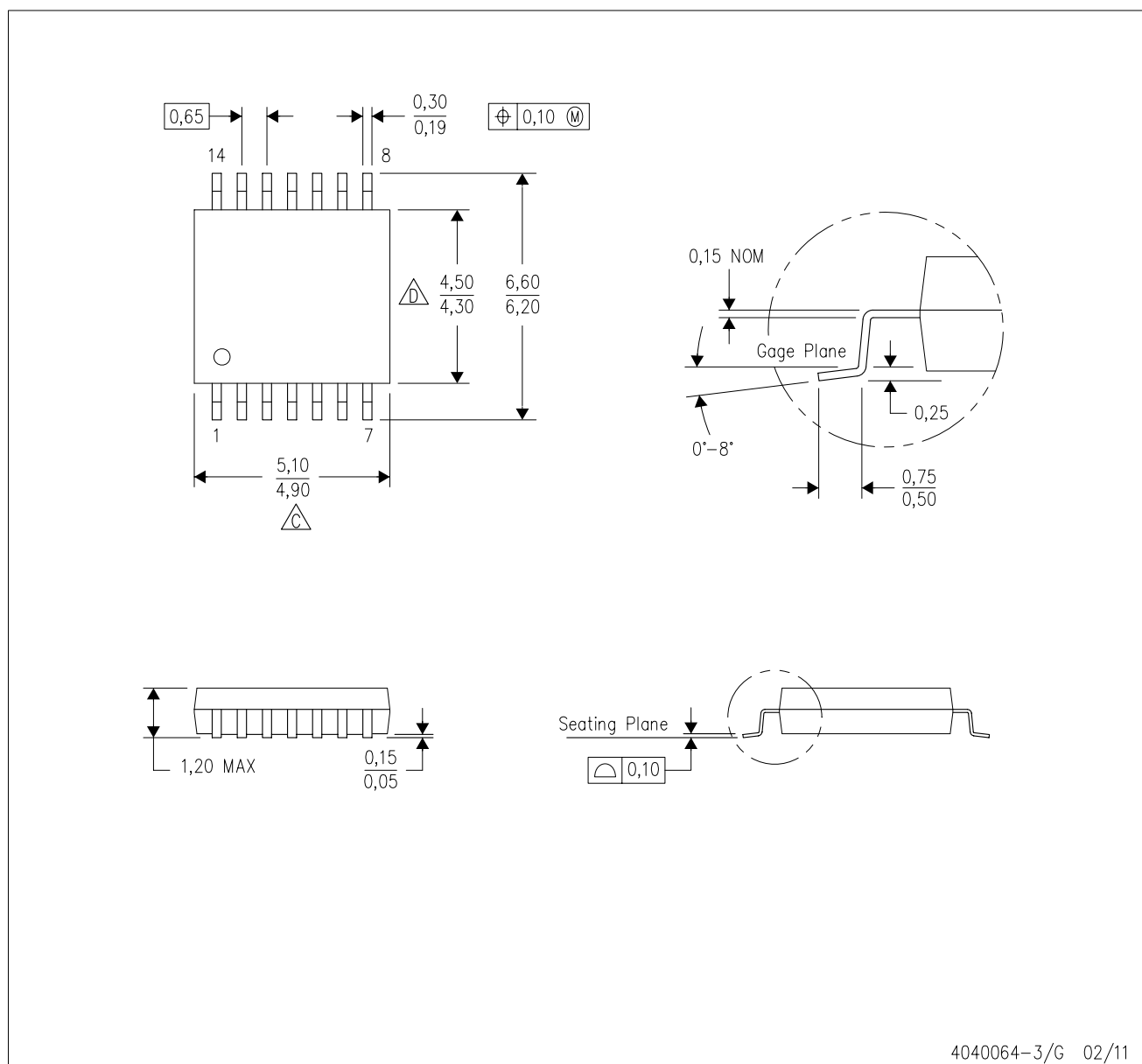
PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Publication IPC-7351 is recommended for alternate designs.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

PW (R-PDSO-G14)

PLASTIC SMALL OUTLINE

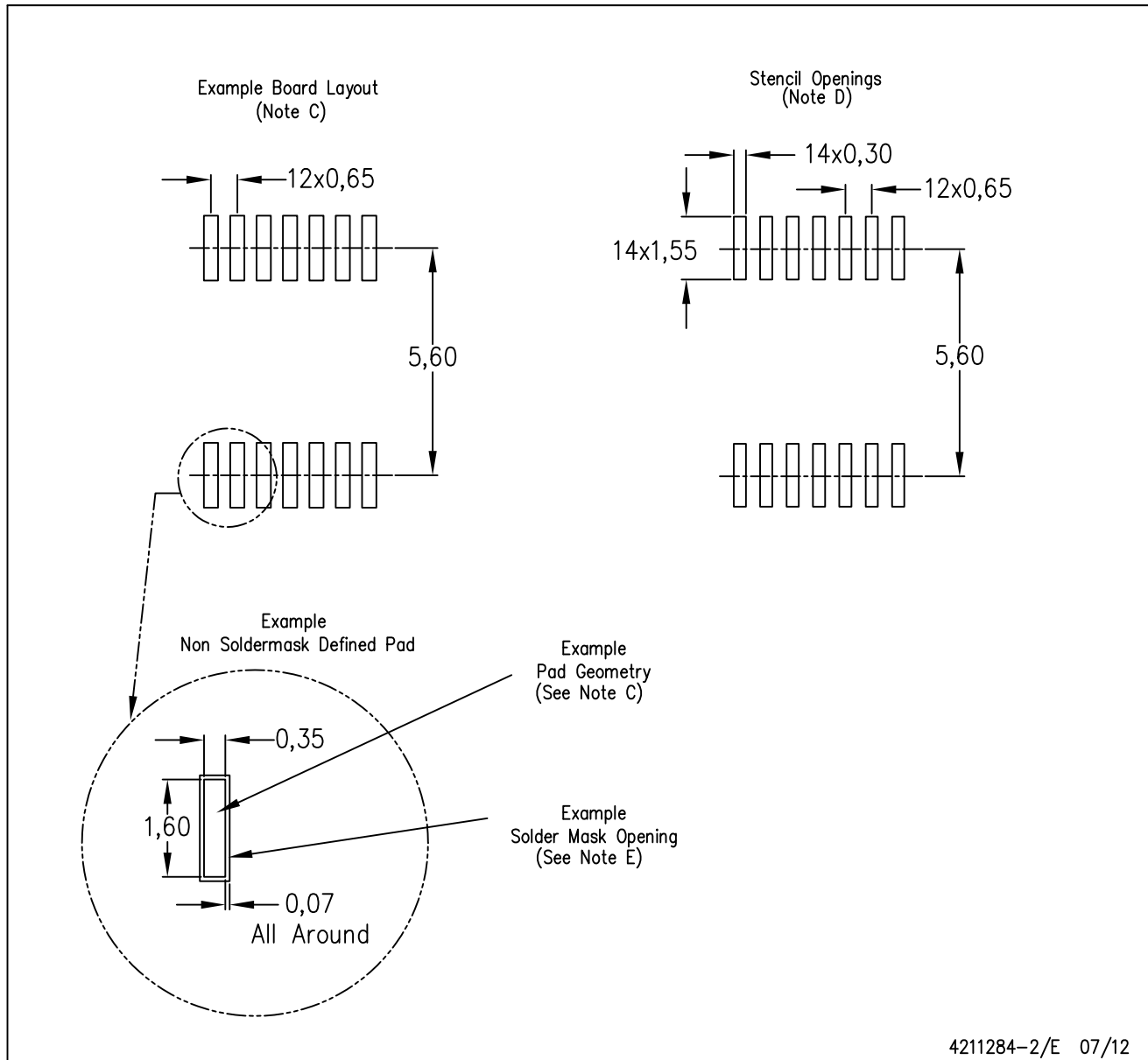


4040064-3/G 02/11

- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.
  - D. Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.
  - E. Falls within JEDEC MO-153

PW (R-PDSO-G14)

PLASTIC SMALL OUTLINE



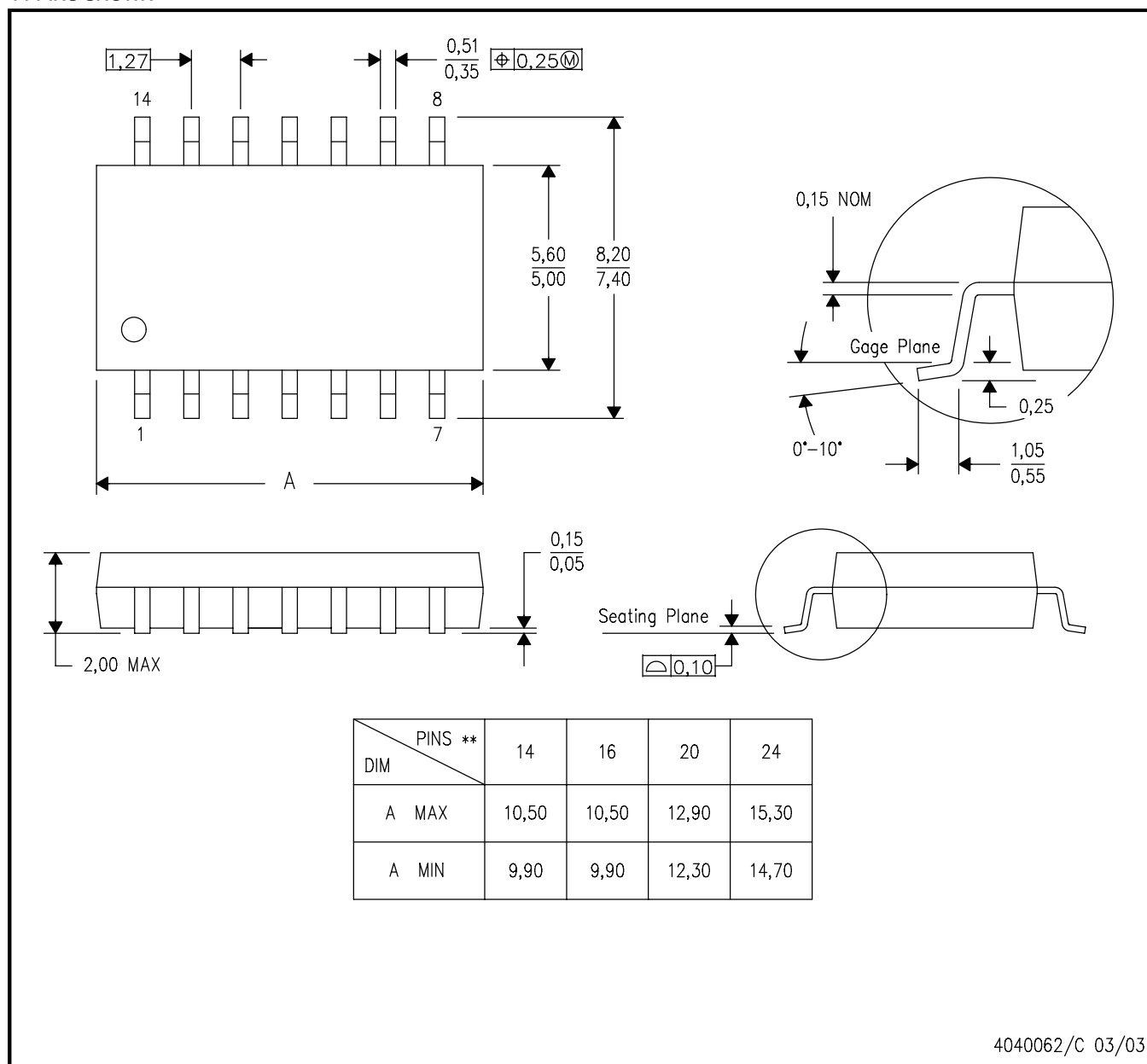
- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Publication IPC-7351 is recommended for alternate designs.
  - Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

# MECHANICAL DATA

NS (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN

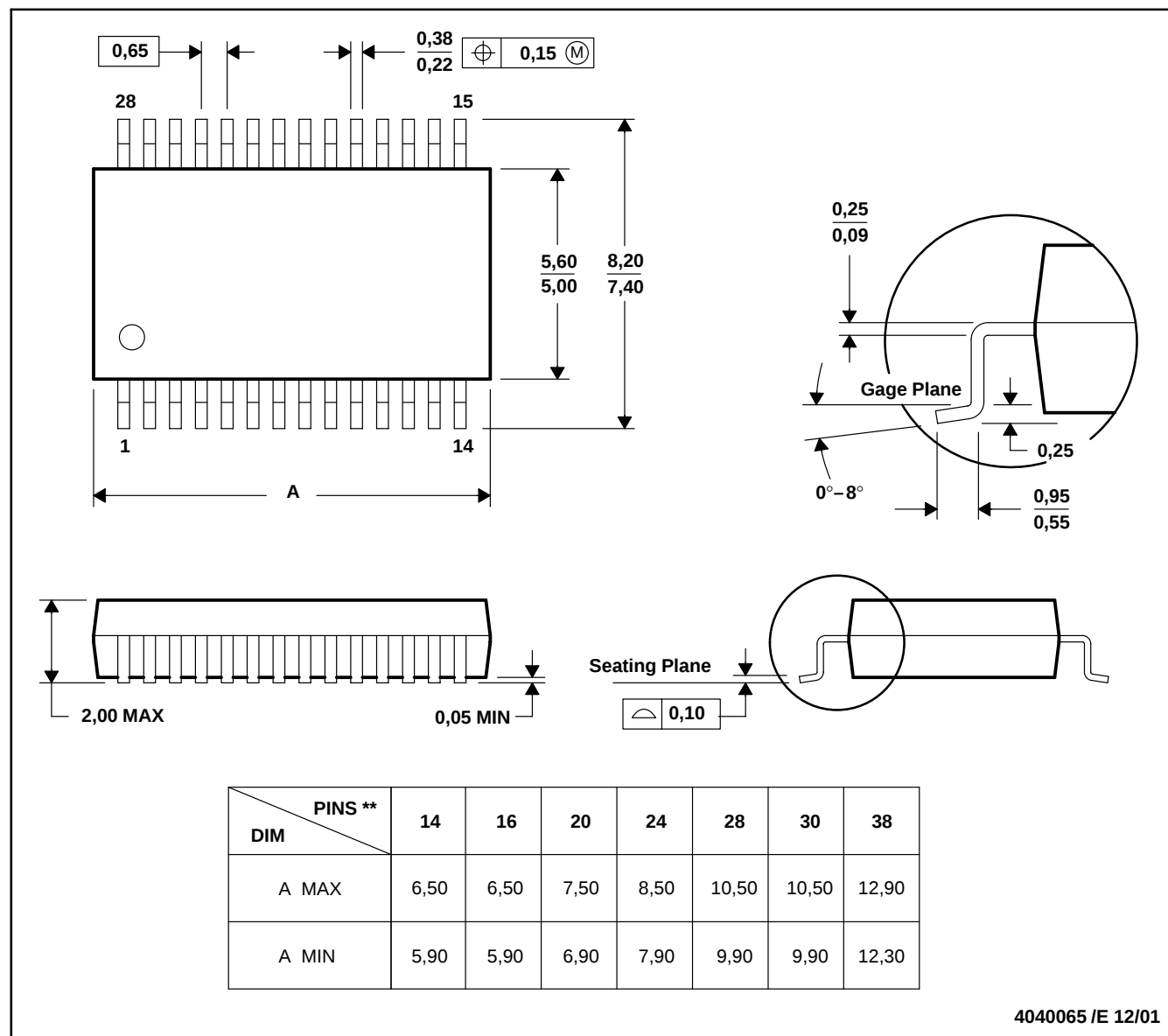


- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

## DB (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

28 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-150

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